

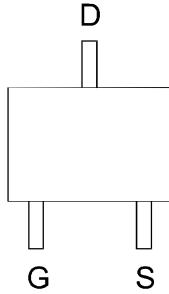
P-Channel 20V(D-S) MOSFET
GENERAL DESCRIPTION

The ME2313 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION

(SOT-23)

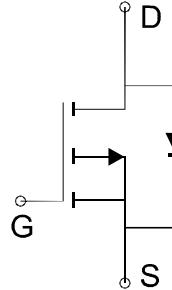
Top View


FEATURES

- $R_{DS(ON)} \leq 48\text{m}\Omega @ V_{GS} = -10\text{V}$
- $R_{DS(ON)} \leq 52\text{m}\Omega @ V_{GS} = -4.5\text{V}$
- $R_{DS(ON)} \leq 65\text{m}\Omega @ V_{GS} = -2.5\text{V}$
- $R_{DS(ON)} \leq 85\text{m}\Omega @ V_{GS} = -1.8\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter


Ordering Information: ME2313 (Pb-free)

ME2313 -G (Green product-Halogen free)

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Maximum Ratings	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current	I_D	-4.3	A
		-3.4	
Pulsed Drain Current	I_{DM}	-17	A
Maximum Power Dissipation	P_D	1.4	W
		0.9	
Storage Temperature Range	T_{STG}	-55 to 150	°C
Thermal Resistance-Junction to Ambient*	$R_{\theta JA}$	90	°C/W

*The device mounted on 1in² FR4 board with 2 oz copper


P-Channel 20V(D-S) MOSFET
Electrical Characteristics (T_j=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250 μA	-20			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250 μA	-0.5		-1.5	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±8V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V			-1	μA
R _{Ds(ON)}	Drain-Source On-Resistance	V _{GS} =-10V, I _D = -5.1A		40	48	mΩ
		V _{GS} =-4.5V, I _D = -4.5A		43	52	
		V _{GS} =-2.5V, I _D = -3.7A		52	65	
		V _{GS} =-1.8V, I _D = -1.7A		60	85	
V _{SD}	Diode Forward Voltage	I _S =-4.1A, V _{GS} =0V		-0.8	-1.2	V
DYNAMIC						
Q _g	Total Gate Charge	V _{DS} =-10V, V _{GS} =-4.5V, I _D =-5.1A		10.5		nC
Q _g	Total Gate Charge	V _{DS} =-10V, V _{GS} =-2.5V, I _D =-5.1A		6.2		
Q _{gs}	Gate-Source Charge			2.8		
Q _{gd}	Gate-Drain Charge			2.3		
R _g	Gate-Resistance	V _{DS} =0V, V _{GS} =0V, F=1MHz		7.7		Ω
C _{iss}	Input Capacitance	V _{DS} =-10V, V _{GS} =0V, f=1MHz		934		pF
C _{oss}	Output Capacitance			93.7		
C _{rss}	Reverse Transfer Capacitance			30.3		
t _{d(on)}	Turn-On Delay Time	V _{DS} =-10V, R _L =10Ω R _{GEN} =1Ω, V _{GS} =-10V I _D =-4.1A		36.1		ns
t _r	Turn-On Rise Time			21.7		
t _{d(off)}	Turn-Off Delay Time			59.4		
t _f	Turn-Off Fall Time			5		

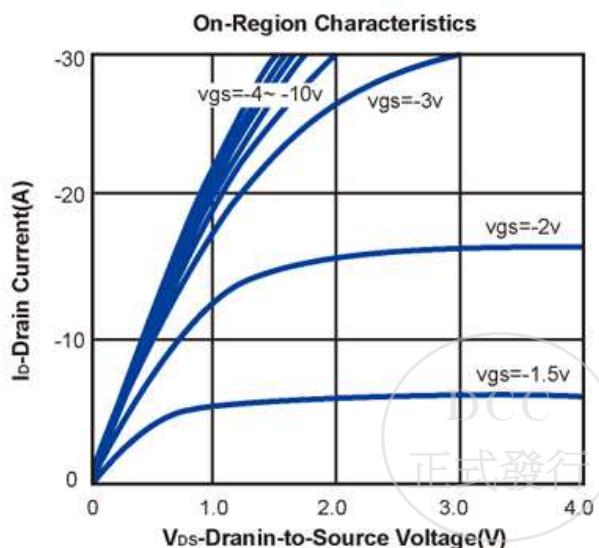
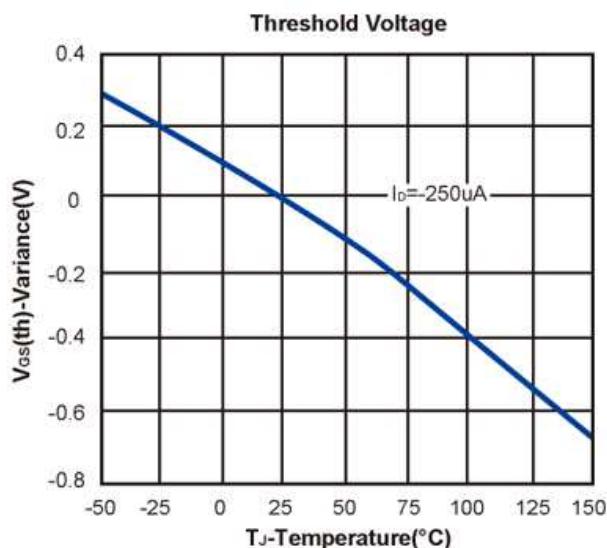
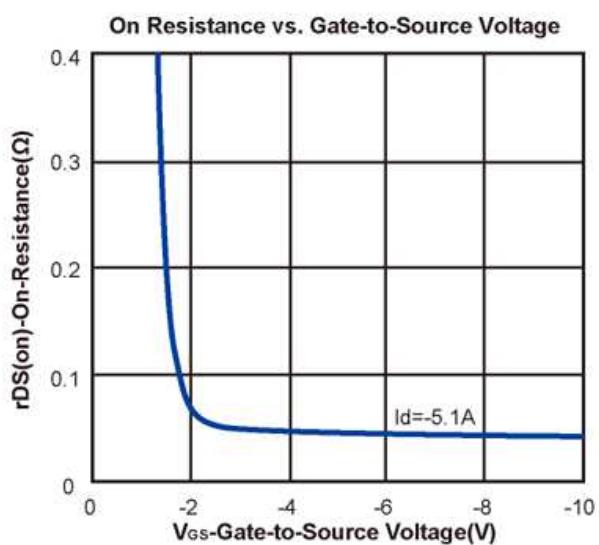
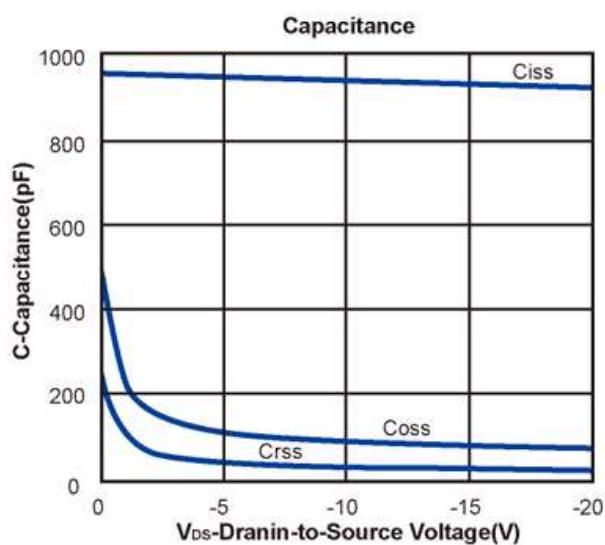
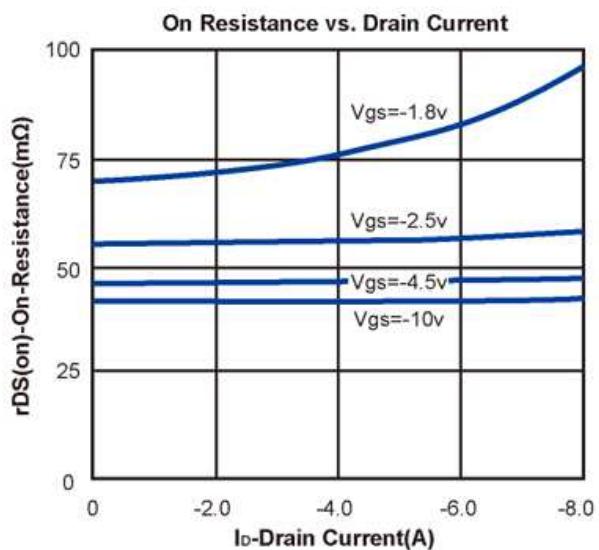
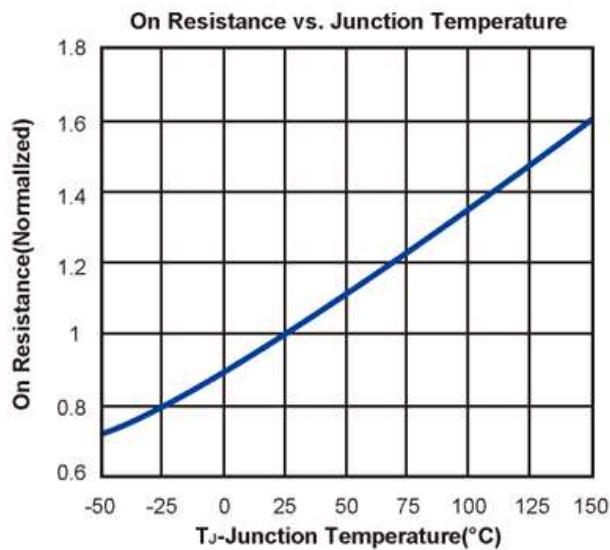
Notes: a. Pulse test; pulse width ≤ 300us, duty cycle≤ 2%

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



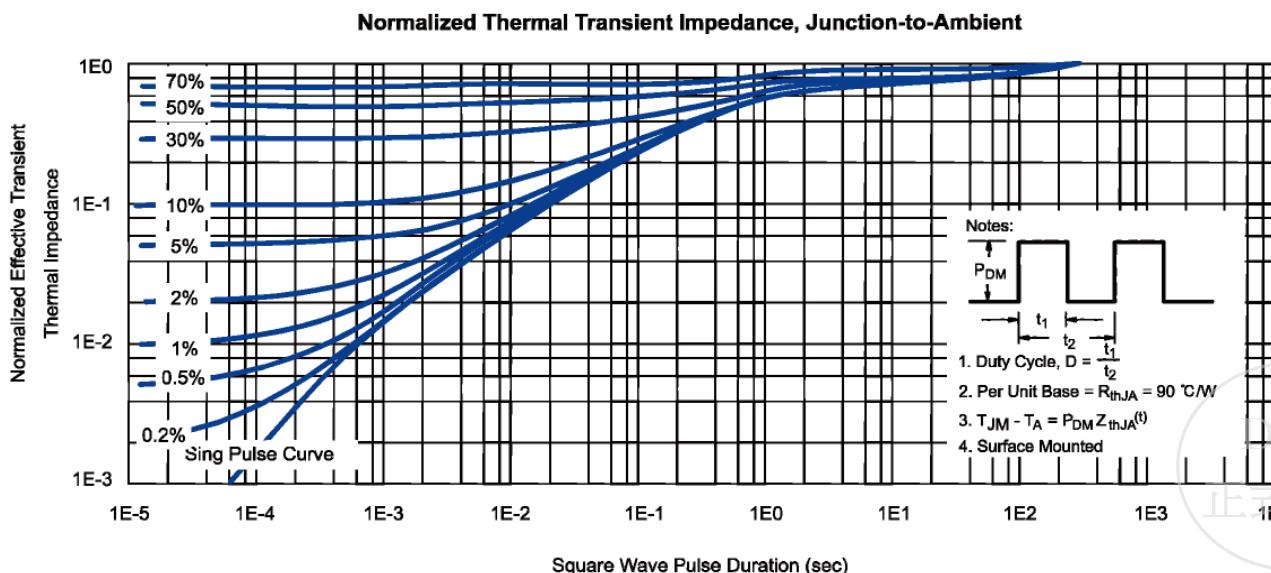
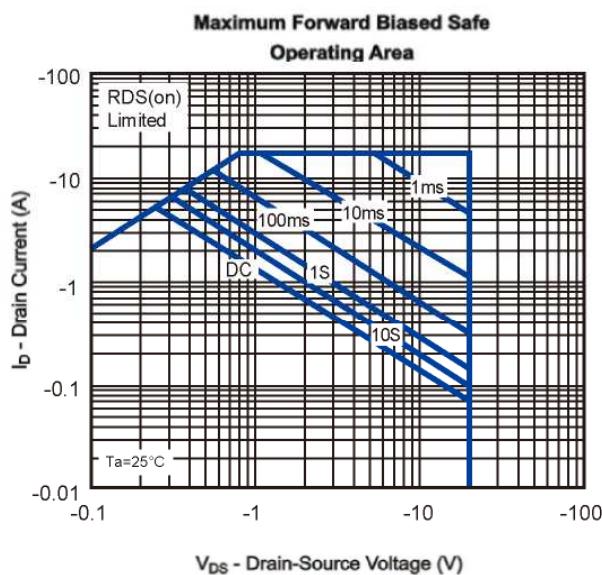
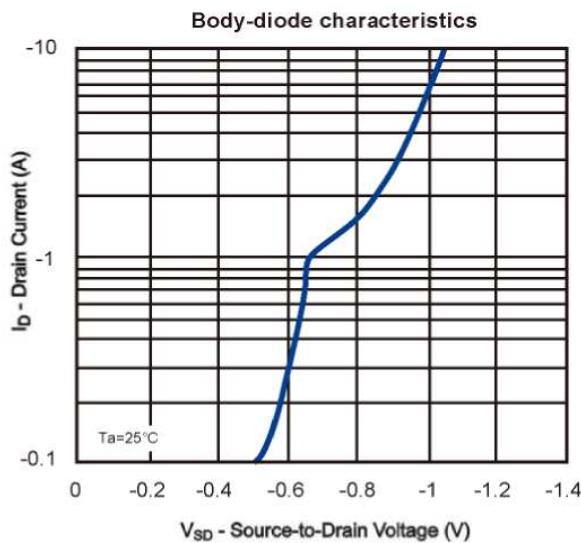
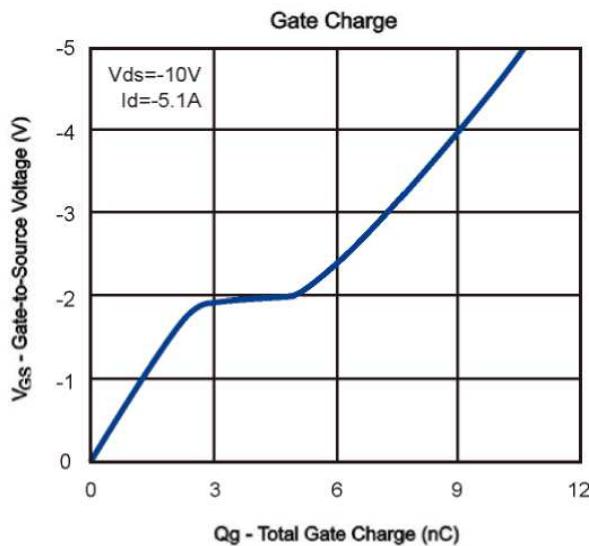
P-Channel 20V(D-S) MOSFET

Typical Characteristics (T_J =25°C Noted)

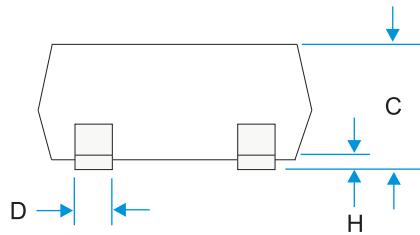
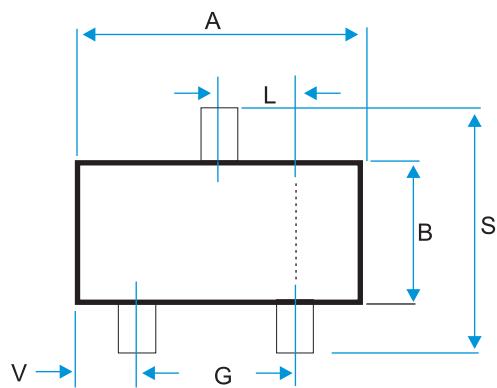


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Typical Characteristics (T_J = 25°C Noted)



SOT-23 Package Outline



DIM	MILLIMETERS (mm)	
	MIN	MAX
A	2.800	3.00
B	1.200	1.70
C	0.900	1.30
D	0.350	0.50
G	1.780	2.04
H	0.010	0.15
J	0.085	0.20
K	0.300	0.65
L	0.890	1.02
S	2.100	3.00
V	0.450	0.60

